

EFFECT OF Ni-DOPED ON SURFACE OF TITANIUMDIOXIDE THIN FILM

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TiO₂ thin film was prepared by sol-gel method and dip coating on glass fiber roving. The structure of TiO₂ thin film was determined by XRD. XPS analysis confirmed that Ti and Ni are present on the surface of the catalysts and AFM showed morphologies and roughness of TiO₂ thin film. The result showed anatase phase and Ni(OH)₂ structure on Ni doped TiO₂ films. Ni doped effect to porous structures of TiO₂ thin film. The roughness increase with increase the volume of Ni and Ni doping is effect to the roughness and the cracking on TiO₂ surface.

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1. Introduction

The air pollution can be found both outdoors and indoors. Pollutants can be trapped inside buildings, causing indoor pollution. And indoor air pollution is emitted from furniture, electrical appliances, gas combustion. The indoor environment is important in human health, because people generally living indoor more than 80% of their time. Therefore, air purification process is required to reduce or remove the hazardous organic matter and microbial from air. Photocatalytic oxidation is a new technique for the reduction of volatile organic compounds of indoor air. This process is performed by activation of photocatalyst using ultraviolet or visible light to produce primarily hydroxyl and superoxide radicals which are the active sites on TiO₂ surfaces for oxidizing volatile organic compounds of indoor air to the final products as water vapour and carbon dioxide [1]. Titanium dioxide (TiO₂) is an excellent photocatalyst. It is widely used as a photocatalyst because it is relatively highly efficient, cheap, non-toxic, chemically and biologically inert and photo stable. TiO₂ in the anatase phase has been used as an excellent photocatalyst and it is well application for purification [2-3]. However, the efficiency of TiO₂ photocatalytic is low for its application. The effective ways to improve the TiO₂ photocatalytic activity such as improving photocatalytic activity [4-5] and increasing surface activation sites [6]. Many researchers have the studied the behaviour of introduced metal ions into TiO₂ such as Ag [7-8] for photocatalytic activity efficiency and added organic compound into TiO₂ such as TEA [9] and PEG [10] for increasing surface. However, organic compounds are effect to hindrance anatase-rutile phase transformation. The doped Ni may improve the photocatalytic activity of TiO₂, which is considered to be a probable electron acceptor in TiO₂ thin film and improving roughness of TiO₂ film so in this study we interested TiO₂ doped with transition metallic Ni was synthesized by sol-gel method for modified surface structure and surface area of TiO₂ film.

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2. Experimental

2.1 Raw materials

Materials used for synthesis of pure TiO₂ and TiO₂-Ni composite films were titanium (IV) isopropoxide (99%) (Fluka Sigma-Aldrich), Nickel nitrate (Ni(NO₃)₂·6H₂O, Wako), Absolute ethanol (RCI Labskan) and nitric acid were both AR grade

2.2 Sample preparation

Pure TiO₂ and Ni doped TiO₂ films coated on glass slide were prepared by sol-gel method. Titanium (IV) isopropoxide of 10 ml was added into 100 ml ethanol (95%) and it was mixed with the solution prepared by dropping nickel nitrate in 50 ml ethanol. The pH of mixed solution was adjusted to about 5 and it was vigorously stirred at room temperature for 1h until sol was formed. Glass slide was coated with as prepared sol by dip coating and oven drying at 100 °C for 12 h before calcinations at 500 °C for 1h with a heating rate of 10 °C /min.

2.3 Characterization

Microstructure of TiO₂ composite thin films were determined from X-ray diffraction (XRD, RIGAKU TTRAX III, 18 kW, Japan glancing angle X-ray diffraction = 0.4). The data were taken in the range of 10-70 (2θ). The average crystallite size was determined from the X-ray diffraction pattern using Scherer's equation [13]. Structure of doping was determined by X-ray Photoelectron Spectroscopy (XPS, AXIS Ultra DLD, Kratos analytical Ltd.). The surface morphologies and surface roughness of pure TiO₂ and TiO₂ composites films coated on glass slide were observed by using atomic force microscope (AFM, SPA400, SEIKO).

3. Results and discussion

3.1 Characterization

The synthesis of pure TiO₂ and TiO₂ doped Ni films were prepared by sol-gel. The result showed that un-doped TiO₂ sol exhibited clear solution while as TiO₂-Ni showed light green solution because the raw material of Ni is Ni(NO₃)₂·6H₂O is change to Ni(OH)₂ which is yellowish. The XRD pattern of pure TiO₂ and TiO₂-Ni films are coated on glass slide and calcinaed at 500°C showed in Fig.1. The pure TiO₂ exhibit well crystallized anatase phase. XRD peak at 2θ = 25° was anatase main peak of pure TiO₂. Whereas TiO₂ doped Ni exhibited lower crystallized anatase phase. This is interesting to note that the crystallization of anatase phase decrease with an increase Ni content.

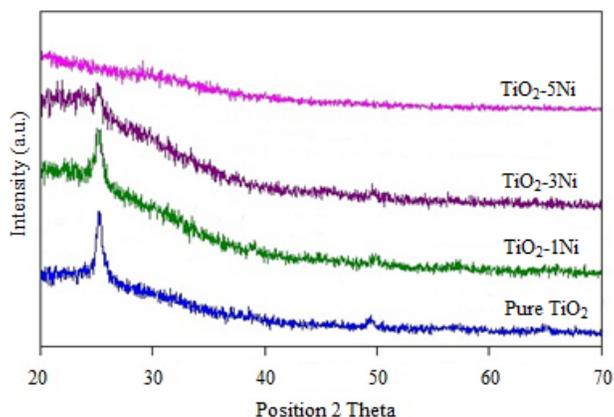


Fig. 1. XRD patterns of pure TiO₂ and Ni doped TiO₂ thin films.

The valance state and the spectra of pure TiO_2 film was examined by XPS analysis as shown in Fig.2. $\text{Ti } 2p_{1/2}$ and $\text{Ti } 2p_{3/2}$, peaks are observed at 464.1 eV. and 458.4 eV., respectively. The splitting between the $\text{Ti } 2p_{1/2}$ and $\text{Ti } 2p_{3/2}$ is 5.7 eV., demonstrating a normal state of Ti^{4+} ion in the catalyst [11].

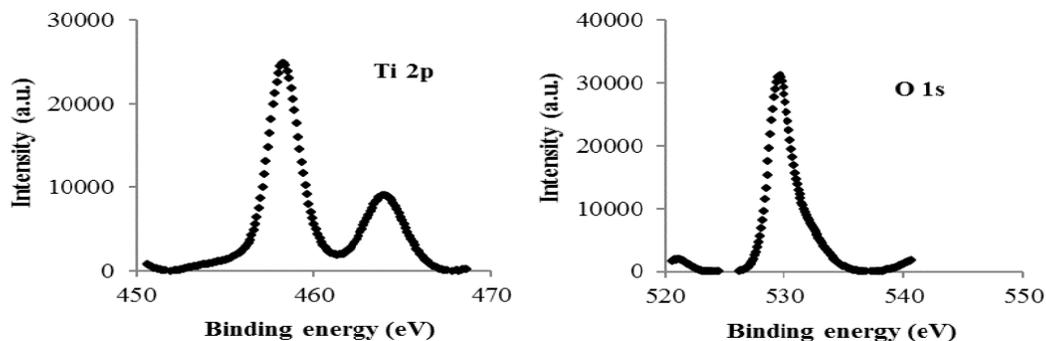


Fig. 2. The XPS spectra of pure TiO_2 film

Fig. 3. shows XPS spectra of $\text{Ti } 2p$, $\text{O } 1s$ and $\text{Ni } 2p$ spectrum of $\text{TiO}_2\text{-Ni}$. $\text{Ti } 2p$, $\text{Ti } 2p_{3/2}$ and $\text{Ti } 2p_{1/2}$, peaks are observed at 458.1 and 463.8 eV, respectively. The splitting between the $\text{Ti } 2p_{1/2}$ and $\text{Ti } 2p_{3/2}$ is 5.7 eV, demonstrating a normal state of Ti^{4+} ion in the catalyst [12]. The binding energies of $\text{O } 1s$ is 529.4 eV is O^{2-} in TiO_2 ($-\text{Ti}-\text{O}-\text{Ti}$). The XPS spectrum of Ni showed at 855.3 eV for $\text{Ni } 2p_{3/2}$ peak at 854.5 to 854.9 eV is NiO structure and then peak at 853.0 is NiTiO_3 nickel metal [13]. At 855.7 eV could be assigned to $\text{Ni}(\text{OH})_2$ [14,15]. This result indicate that the surface of pure TiO_2 was covered with $\text{Ni}(\text{OH})_2$ layer with a thickness less than about 3 nm. $\text{Ni}(\text{OH})_2$ on the Ni surface formed as a consequence of the reaction between the metallic Ni on surface of TiO_2 and water in the air [16].

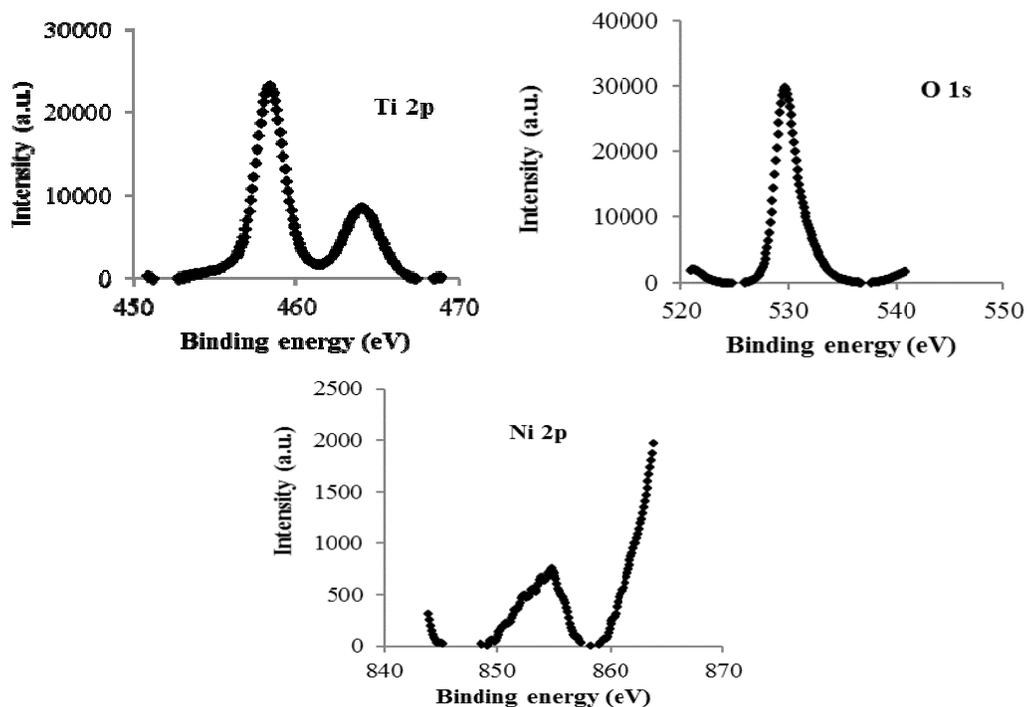


Fig. 3. The XPS spectra of Ni doped TiO_2 films.

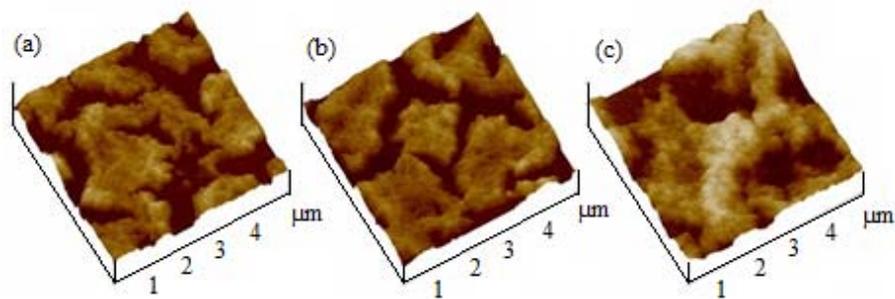


Fig. 4. AFM images of (a) $\text{TiO}_2\text{-1Ni}$ (b) $\text{TiO}_2\text{-3Ni}$ and (c) $\text{TiO}_2\text{-5Ni}$.

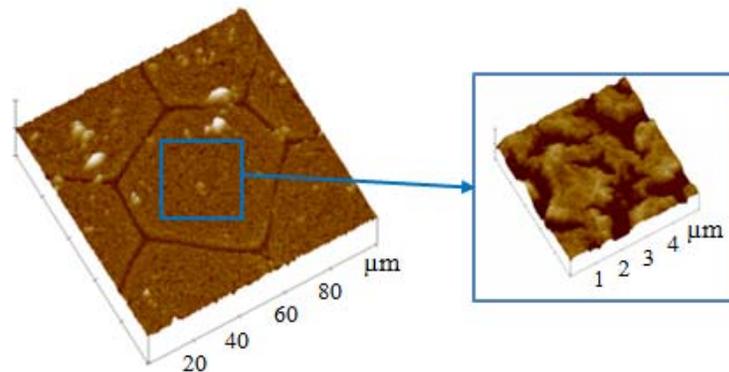


Fig. 5. AFM images of cracking of $\text{TiO}_2\text{-1Ni}$

AFM is used to characterize the change of surface morphology of Ni-doped TiO_2 films taken from three samples. The studied surfaces are equal to $5 \times 5 \mu\text{m}$ in area. These porous film structures were clearly observed by AFM images as shown in Figure 4. It was found that TiO_2 doped Ni has high surface roughness and the roughness increase with increase nickel from 1-5 mol% showed as table 1. Moreover Ni doped TiO_2 were prepared by sol-gel method and calcined at the temperature 500°C . It observed that Ni substitution of the Ti sites forming nickel titanate (NiTiO_3) structure with initial cracking on TiO_2 surface showed as in Figure 5.

4. Conclusion

The preparation of pure TiO_2 and Ni doped TiO_2 films were prepared by sol-gel method. The result showed that the structure of Ni doped TiO_2 exhibit lower crystallized anatase phase than pure TiO_2 because Ni hinder anatase phase transformation. The valance state is Ti^{4+} and the spectrum showed of pure TiO_2 are observed at 464.1eV ($\text{Ti } 2p_{1/2}$) and 458.4 eV ($\text{Ti } 2p_{3/2}$), respectively. The spectrum $\text{Ti } 2p_{3/2}$ and $\text{Ti } 2p_{1/2}$ of Ni doped TiO_2 is shift to lower energy than pure TiO_2 cause of Ni doping in TiO_2 structure. And the XPS spectrum of Ni showed at 855.3 eV for Ni $2p_{3/2}$ this result indicate that the $\text{Ni}(\text{OH})_2$ structure. Moreover, It was found that TiO_2 doped Ni has high surface roughness and the roughness increase with increase nickel from 1-5 mol%.

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